L Number	Hits	Search Text	DB	Time stamp
15	4	6353265.URPN.	USPAT	2003/06/30 07:08
16	3	("6087722" | "6118184" | "6265760").PN.	USPAT	2003/06/30 07:09
129	4	6291881.URPN.	USPAT	2003/06/30 07:12
130	7	("5530292" | "5545922" | "5793108" | "5917242" | "5952725" | "5959347" | "6002178").PN.	USPAT	2003/06/30 07:13
249	47	("4410905" | "4595945" | "4780795" | "4862245" | "4937656" | "4949161" | "5086018" | "5147815" | "5229329" | "5229639" | "5233220" | "5250840" | "5256598" | "5303120" | "5327009" | "5331200" | "5360992" | "5381036" | "5384488" | "5396701" | "5434106" | "5438478" | "5508565" | "5519576" | "5521426" | "5523617" | "5528075" | "5530292" | "5532189" | "5541446" | "5563443" | "5585667" | "5585668" | "5589420" | "5592020" | "5612259" | "5637915" | "5696665" | "5726860" | "5780925" | "5789808" | "5804870" | "5804871" | "5843809" | "5903050" | "5903443" | "5907769").PN.	USPAT	2003/06/30 07:17
250	1	6144089.URPN.	USPAT	2003/06/30 07:18
595	53	5495398.URPN.	USPAT	2003/06/30 07:37
602	10	("3925801" | "4809054" | "4975763" | "5014112" | "5049527" | "5151559" | "5295044" | "5296737" | "5327325" | "5331235").PN.	USPAT	2003/06/30 07:39
717	1195	(chip adj1 chip) and (leadframe (lead adj frame))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 07:56
718	440	((chip adj1 chip) and (leadframe (lead adj frame))) and memory	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 07:57
719	12874	(chip adj1 chip) ((second near1 (chip die)) near3 (attach$3 stacked mounted mounting))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 07:56
720	1477	((chip adj1 chip) ((second near1 (chip die)) near3 (attach$3 stacked mounted mounting))) and (leadframe (lead adj frame))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 07:57
721	542	(((chip adj1 chip) ((second near1 (chip die)) near3 (attach$3 stacked mounted mounting))) and (leadframe (lead adj frame))) and memory	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 07:57
722	142	((((chip adj1 chip) ((second near1 (chip die)) near3 (attach$3 stacked mounted mounting))) and (leadframe (lead adj frame))) and memory) and (((die mounting) adj pad) (mounting adj area) (metal adj base))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 08:40
723	5	("5754567" | "6100594" | "6125061" | "6157080" | "6265783").PN.	USPAT	2003/06/30 08:01
724	12	6100594.URPN.	USPAT	2003/06/30 08:02
725	3	("6087722" | "6118184" | "6265760").PN.	USPAT	2003/06/30 08:07
726	4	("5012323" | "5689135" | "5804874" | "5898212").PN.	USPAT	2003/06/30 08:08
727	93	5012323.URPN.	USPAT	2003/06/30 08:09
728	3	5646830.URPN.	USPAT	2003/06/30 08:12
729	9	("4472876" | "4751482" | "4801999" | "5010390" | "5012323" | "5150194" | "5347429" | "5400218" | "5422435").PN.	USPAT	2003/06/30 08:13
730	16	5150194.URPN.	USPAT	2003/06/30 08:18
731	10	("4541003" | "5502289" | "5614766" | "5640044" | "5801432" | "5814881" | "6025648" | "RE36613" | "6072243" | "6077724").PN.	USPAT	2003/06/30 08:23
732	10	5814881.URPN.	USPAT	2003/06/30 08:24

733	9	("5502289" | "5814881" | "5952725" | "6005778" | "6087722" | "6198136" | "6208018" | "6215182" | "6316838" | "2002/0017718").PN.	USPAT	2003/06/30 08:26
734	16	("5012323" | "5049979" | "5128831" | "5291061" | "5323060" | "5331235" | "5365409" | "5422435" | "5434745" | "5438224" | "5455445" | "5581498" | "5608262" | "5625235" | "5644167" | "5930599").PN.	USPAT	2003/06/30 08:27
735	11	("5012323" | "5296737" | "5331235" | "5347429" | "5438224" | "5463253" | "5471369" | "5479051" | "5523608" | "5545922" | "5640044").PN.	USPAT	2003/06/30 08:29
736	10	("5243208" | "5386623" | "5717245" | "5783870" | "5894166" | "5923090" | "5923091" | "5946545" | "5995379" | "6057598").PN.	USPAT	2003/06/30 08:32
737	5	6255736.URPN.	USPAT	2003/06/30 08:33
738	18	"6025640"	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 08:47
739	14	6025640.URPN.	USPAT	2003/06/30 08:48
740	2	("5592025" | "5635755").PN.	USPAT	2003/06/30 08:48

L Number	Hits	Search Text	DB	Time stamp
15	4	6353265.URPN.	USPAT	2003/06/30 07:08
16	3	("6087722" | "6118184" | "6265760").PN.	USPAT	2003/06/30 07:09
129	4	6291881.URPN.	USPAT	2003/06/30 07:12
130	7	("5530292" | "5545922" | "5793108" | "5917242" | "5952725" | "5959347" | "6002178").PN.	USPAT	2003/06/30 07:13
249	47	("4410905" | "4595945" | "4780795" | "4862245" | "4937656" | "4949161" | "5086018" | "5147815" | "5229329" | "5229639" | "5233220" | "5250840" | "5256598" | "5303120" | "5327009" | "5331200" | "5360992" | "5381036" | "5384488" | "53396701" | "5434106" | "5438478" | "5508565" | "5519576" | "5521426" | "5523617" | "5528075" | "5530292" | "5532189" | "5541446" | "5563443" | "5585667" | "5585668" | "5589420" | "5592020" | "5612259" | "5637915" | "5696665" | "5726860" | "5780925" | "5789808" | "5804870" | "5804871" | "5843809" | "5903050" | "5903443" | "5907769").PN.	USPAT	2003/06/30 07:17
250	1	6144089.URPN.	USPAT	2003/06/30 07:18
595	53	5495398.URPN.	USPAT	2003/06/30 07:37
602	10	("3925801" | "4809054" | "4975763" | "5014112" | "5049527" | "5151559" | "5295044" | "5296737" | "5327325" | "5331235").PN.	USPAT	2003/06/30 07:39
717	1195	(chip adj1 chip) and (leadframe (lead adj frame))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 07:56
718	440	((chip adj1 chip) and (leadframe (lead adj frame))) and memory	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 07:57
719	12874	(chip adj1 chip) ((second near1 (chip die)) near3 (attach$3 stacked mounted mounting))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 08:51
720	1477	((chip adj1 chip) ((second near1 (chip die)) near3 (attach$3 stacked mounted mounting))) and (leadframe (lead adj frame))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 08:59
721	542	(((chip adj1 chip) ((second near1 (chip die)) near3 (attach$3 stacked mounted mounting))) and (leadframe (lead adj frame))) and memory	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 07:57
722	142	((((chip adj1 chip) ((second near1 (chip die)) near3 (attach$3 stacked mounted mounting))) and (leadframe (lead adj frame))) and memory) and (((die mounting) adj pad) (mounting adj area) (metal adj base))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 09:01
723	5	("5754567" | "6100594" | "6125061" | "6157080" | "6265783").PN.	USPAT	2003/06/30 08:01
724	12	6100594.URPN.	USPAT	2003/06/30 08:02
725	3	("6087722" | "6118184" | "6265760").PN.	USPAT	2003/06/30 08:07
726	4	("5012323" | "5689135" | "5804874" | "5898212").PN.	USPAT	2003/06/30 08:08
727	93	5012323.URPN.	USPAT	2003/06/30 08:09
728	3	5646830.URPN.	USPAT	2003/06/30 08:12
729	9	("4472876" | "4751482" | "4801999" | "5010390" | "5012323" | "5150194" | "5347429" | "5400218" | "5422435").PN.	USPAT	2003/06/30 08:13
730	16	5150194.URPN.	USPAT	2003/06/30 08:18
731	10	("4541003" | "5502289" | "5614766" | "5640044" | "5801432" | "5814881" | "6025648" | "RE36613" | "6072243" | "6077724").PN.	USPAT	2003/06/30 08:23
732	10	5814881.URPN.	USPAT	2003/06/30 08:24

733	9	("5502289" | "5814881" | "5952725" | "6005778" | "6087722" | "6198136" | "6208018" | "6215182" | "6316838" | "2002/0017718").PN.	USPAT	2003/06/30 08:26
734	16	("5012323" | "5049979" | "5128831" | "5291061" | "5323060" | "5331235" | "5365409" | "5422435" | "5434745" | "5438224" | "5455445" | "5581498" | "5608262" | "5625235" | "5644167" | "5930599").PN.	USPAT	2003/06/30 08:27
735	11	("5012323" | "5296737" | "5331235" | "5347429" | "5438224" | "5463253" | "5471369" | "5479051" | "5523608" | "5545922" | "5640044").PN.	USPAT	2003/06/30 08:29
736	10	("5243208" | "5386623" | "5717245" | "5783870" | "5894166" | "5923090" | "5923091" | "5946545" | "5995379" | "6057598").PN.	USPAT	2003/06/30 08:32
737	5	6255736.URPN.	USPAT	2003/06/30 08:33
738	18	"6025640"	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 08:47
739	14	6025640.URPN.	USPAT	2003/06/30 08:48
740	2	("5592025" | "5635755").PN.	USPAT	2003/06/30 08:48
741	400	(((((chip adj1 chip) ((second near1 (chip die)) near3 (attach$3 stacked mounted mounting))) and (leadframe (lead adj frame))) and memory) not ((((((chip adj1 chip) ((second near1 (chip die)) near3 (attach$3 stacked mounted mounting))) and (leadframe (lead adj frame))) and memory) and (((die mounting) adj pad) (mounting adj area) (metal adj base)))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 08:50
742	95	((((((chip adj1 chip) ((second near1 (chip die)) near3 (attach$3 stacked mounted mounting))) and (leadframe (lead adj frame))) and memory) not ((((((chip adj1 chip) ((second near1 (chip die)) near3 (attach$3 stacked mounted mounting))) and (leadframe (lead adj frame))) and memory) and (((die mounting) adj pad) (mounting adj area) (metal adj base)))) and ((second near (chip die)) near3 (attach$3 stacked mounted mounting))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 08:51
743	2384	257/777 438/109	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 08:58
744	579	((leadframe (lead adj frame)) (lead adj finger)) near3 (grounding ground)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 09:01
745	56327	((leadframe (lead adj frame)) (lead adj finger))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 09:01
746	365	(grounding ground) near3 (((die mounting) adj pad) (mounting adj area) (metal adj base))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 09:04
747	5	(257/777 438/109) and ((grounding ground) near3 (((die mounting) adj pad) (mounting adj area) (metal adj base)))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 09:03
748	40569	(257/777 438/109) (((die mounting) adj pad) (metal adj base))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 09:04

749	245	(257/777 438/109) and (((die mounting) adj pad) (metal adj base))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 09:04
750	170	(((leadframe (lead adj frame)) (lead adj finger))) and ((257/777 438/109) and (((die mounting) adj pad) (metal adj base)))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 09:05
751	136	((((leadframe (lead adj frame)) (lead adj finger))) and ((257/777 438/109) and (((die mounting) adj pad) (metal adj base)))) not (((((chip adj1 chip) ((second near1 (chip die)) near3 (attach$3 stacked mounted mounting))) and (leadframe (lead adj frame))) and memory) not (((((chip adj1 chip) ((second near1 (chip die)) near3 (attach$3 stacked mounted mounting))) and (leadframe (lead adj frame))) and memory) and (((die mounting) adj pad) (mounting adj area) (metal adj base)))) and ((second near (chip die)) near3 (attach$3 stacked mounted mounting))) not (((((chip adj1 chip) ((second near1 (chip die)) near3 (attach$3 stacked mounted mounting))) and (leadframe (lead adj frame))) and memory) and (((die mounting) adj pad) (mounting adj area) (metal adj base)))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 09:05
752	53	(((((leadframe (lead adj frame)) (lead adj finger))) and ((257/777 438/109) and (((die mounting) adj pad) (metal adj base)))) not (((((chip adj1 chip) ((second near1 (chip die)) near3 (attach$3 stacked mounted mounting))) and (leadframe (lead adj frame))) and memory) not (((((chip adj1 chip) ((second near1 (chip die)) near3 (attach$3 stacked mounted mounting))) and (leadframe (lead adj frame))) and memory) and (((die mounting) adj pad) (mounting adj area) (metal adj base)))) and ((second near (chip die)) near3 (attach$3 stacked mounted mounting))) not (((((chip adj1 chip) ((second near1 (chip die)) near3 (attach$3 stacked mounted mounting))) and (leadframe (lead adj frame))) and memory) and (((die mounting) adj pad) (mounting adj area) (metal adj base)))) and memory	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 09:05
753	4	("5479051" | "6091144" | "6118184" | "6316838").PN.	USPAT	2003/06/30 09:08